

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
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NATURE OF CONVEYANCE:	ASSIGNMENT
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CONVEYING PARTY DATA

Name	Execution Date
Shinya YAMANAKA	08/29/2006

RECEIVING PARTY DATA

Name:	Shinya YAMANAKA
Street Address:	2-9-7-1401, Dougashiba
Internal Address:	Tennoji-ku
City:	Osaka-shi, Osaka
State/Country:	JAPAN
Postal Code:	543-0033

Name:	Dainippon Sumitomo Pharma Co., Ltd.
Street Address:	6-8, Dosho-machi 2-chome
Internal Address:	Chuo-ku
City:	Osaka-shi, Osaka
State/Country:	JAPAN
Postal Code:	541-8524

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	10589905

CORRESPONDENCE DATA

Fax Number: (312)616-5700
Correspondence will be sent via US Mail when the fax attempt is unsuccessful.
 Phone: (312) 616-5600
 Email: assignments@leydig.com
 Correspondent Name: John Kilyk, Jr.
 Address Line 1: Leydig, Voit & Mayer, Ltd.
 Address Line 2: Two Prudential Plaza, Suite 4900

CH \$40.00 10589905

Address Line 4: Chicago, ILLINOIS 60601-6731

ATTORNEY DOCKET NUMBER:

701049

NAME OF SUBMITTER:

John Kilyk, Jr.

Total Attachments: 2

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Leydig, Voit & Mayer, Ltd.
Attorneys at Law
Two Prudential Plaza
Suite 4900
180 North Stetson
Chicago, Illinois 60601-6780

ASSIGNMENT OF APPLICATION FOR PATENT

WHEREAS, WE,

Shinya YAMANAKA of 2-9-7-1401, Dougashiba, Tennoji-ku, Osaka-shi, Osaka 543-0033 Japan
(full name and address, including postal code, of first inventor)

respectively, have invented and own a certain new and useful invention entitled:

SCREENING METHOD FOR SOMATIC CELL NUCLEAR REPROGRAMMING SUBSTANCE

for which invention we have executed an application for Letters Patent of the United States which was filed
on August 18, 2006, under Serial No. 10/589,905 and

WHEREAS,

Shinya YAMANAKA of 2-9-7-1401, Dougashiba, Tennoji-ku, Osaka-shi, Osaka 543-0033 Japan and
Dainippon Sumitomo Pharma Co., Ltd. of 6-8, Dosho-machi 2-chome, Chuo-ku, Osaka-shi, Osaka
541-8524 Japan
(full name and address, including postal code, of assignee)

(hereinafter referred to as Assignee) is desirous of acquiring the entire right, title, and interest in and under the invention described in the application for Letters Patent.

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that for good and valuable considerations, the receipt and sufficiency of which are hereby acknowledged, we have assigned and set over, and by this document do assign and set over, to the Assignee and the Assignee's legal representatives, successors and assigns the entire right, title, and interest in and to the invention in the United States the applications for Letters Patent and other such applications (e.g., continuations, continuations-in-part, divisionals and reissues) in the United States, and the Letters Patent, or extensions thereof, that may or shall issue thereon; and we do hereby authorize and request the Commissioner of Patents and Trademarks to issue the Letters Patent to the above-mentioned Assignee agreeably with the terms of this Assignment.

WE HEREBY AUTHORIZE the above-mentioned Assignee to insert in this assignment document the filing date and serial number of the application if the date and number are unknown at the time this assignment is executed.

WE DO HEREBY COVENANT and agree with the Assignee that we will not execute any writing or do any act whatsoever conflicting with the terms of this assignment document set forth herein, and that we will at any time upon request, without further or additional consideration, but at the expense of the Assignee, execute such additional assignments and other writings and do such additional acts as the Assignee may deem necessary or desirable to perfect the Assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, continuation, renewal, reissued, or extended Letters Patent of the United States or of any and all foreign

countries on the invention, and in enforcing any rights or choses in action accruing as a result of such applications or patents, and by executing preliminary statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of, the assigns and legal representatives of both parties.

IN WITNESS WHEREOF, we have hereunder set our hands on the dates shown below:

S. Yamanaoka
Signature of First Inventor Shinya YAMANAKA

August 29, 2006
Date

Rie Kato August 29, 2006
Witness Rie KATO Date

Naoko Takasu August 29, 2006
Witness Naoko TAKASU Date